



## **General Description**

These N-Channel enhancement mode power field effect transistors are using SGT MOSFET technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

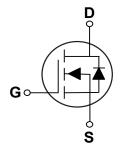
BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub>
40 V	1.34 mΩ	200 A

## **Features**

- $R_{DS(ON)} \le \overline{1.34m\Omega} \overline{@V_{GS}} = \overline{10V}$
- Fast Switching
- · Improved dv/dt Capability
- · Green Device Available

## PPAK5X6 Pin Configuration





## **Applications**

- · BMS
- BLDC
- UPS

Absolute Maximum Ratings T <sub>c</sub> =25°C unless otherwise noted						
Symbol	Parameter	Rating	Units			
$V_{DS}$	Drain-Source Voltage	40	V			
$V_{GS}$	Gate-Source Voltage	±20	V			
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> =25°C)	200	Α			
I <sub>DM</sub>	Drain Current - Pulsed (NOTE 1)	800	Α			
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> =25°C)	89.3	W			
$T_J$	Operating Junction Temperature Range	-55 to 150	°C			
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C			
Marking Code		ND1P3				

Thermal Characteristics					
Symbol	Parameter	Rating	Unit		
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	62	°C/W		
$R_{ heta JC}$	Thermal Resistance Junction to Case	1.4	°C/W		





# Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

#### **Off Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	40			V
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{DS}$ =32V , $V_{GS}$ =0V			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ =±20V , $V_{DS}$ =0V			±100	nA

## **On Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V , I <sub>D</sub> =20A			1.34	- mΩ
		V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A			2.1	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=250uA$	1.0		2.5	V

## **Dynamic and switching Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$Q_g$	Total Gate Charge			125		
$Q_{gs}$	Gate-Source Charge	$V_{DS}$ =20V , $V_{GS}$ =10V , $I_{D}$ =85A		18		nC
$Q_{gd}$	Gate-Drain Charge			13		
$T_{d(on)}$	Turn-On Delay Time			14.1		
T <sub>r</sub>	Rise Time	$V_{DD}$ =20V , $V_{GS}$ =10V , $R_{G}$ =1.6 $\Omega$ , $I_{D}$ =85A		7.9		nS
$T_{d(off)}$	Turn-Off Delay Time			56.5		113
$T_f$	Fall Time			9.6		
C <sub>iss</sub>	Input Capacitance			8300		
$C_{oss}$	Output Capacitance	V <sub>DS</sub> =20V , V <sub>GS</sub> =0V , F=1MHz		1500		pF
$C_{rss}$	Reverse Transfer Capacitance			1480		

# **Drain-Source Diode Characteristics and Ratings**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V <sub>G</sub> =V <sub>D</sub> =0V, Force Current			200	Α
$V_{SD}$	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =20A			1.2	V

## NOTES:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%.
- ${\it 3. Essentially independent of operating temperature.}\\$



# Pb RoHS

# **40V N-Channel MOSFETs**

## **Characteristics Curves**

FIG. 1-Drain Current

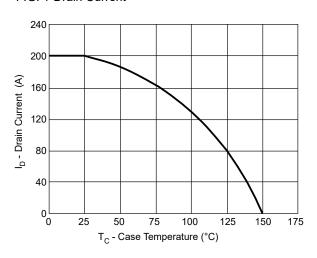


FIG. 2-Normalized BV<sub>DSS</sub> vs T<sub>J</sub>

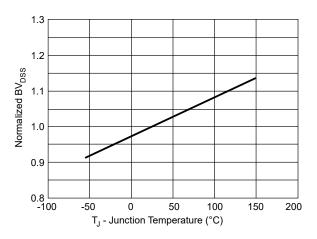


FIG. 3-Normalized  $R_{\text{DS}(\text{ON})}\,\text{vs}\;T_{\text{J}}$ 

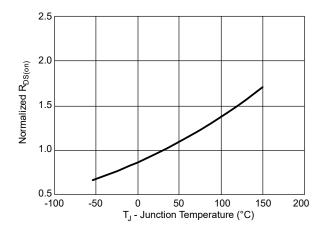


FIG. 4-Gate Charge Characteristics

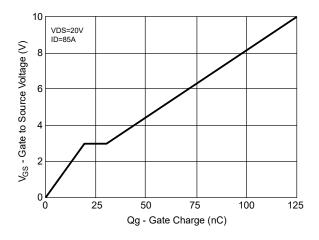


FIG. 5-Safe Operation Area

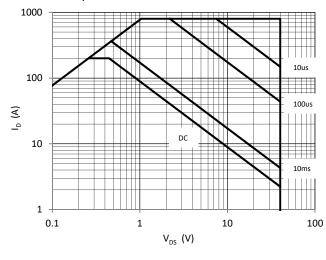
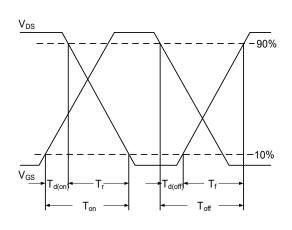


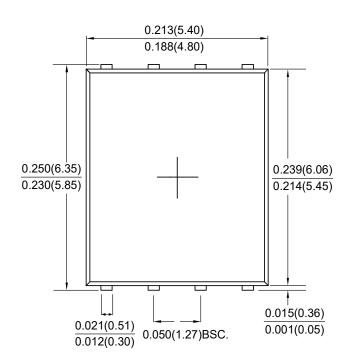
FIG. 6 - Switching Time Waveform

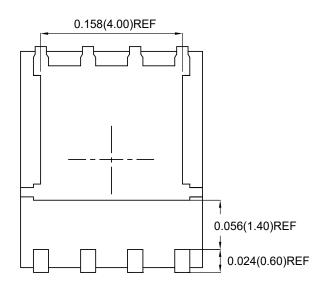


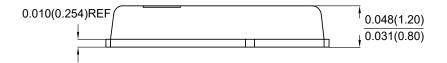


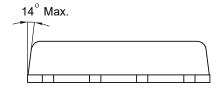


# **Package Outline Dimensions**









PPAK5X6

Dimensions in inches and (millimeters)





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